

NE5532, SA5532, SE5532, NE5532A, SE5532A

Internally Compensated Dual Low Noise Operational Amplifier

The 5532 is a dual high-performance low noise operational amplifier. Compared to most of the standard operational amplifiers, such as the 1458, it shows better noise performance, improved output drive capability and considerably higher small-signal and power bandwidths.

This makes the device especially suitable for application in high-quality and professional audio equipment, instrumentation and control circuits, and telephone channel amplifiers. The op amp is internally compensated for gains equal to one. If very low noise is of prime importance, it is recommended that the 5532A version be used because it has guaranteed noise voltage specifications.

Features

- Small-Signal Bandwidth: 10 MHz
- Output Drive Capability: 600 Ω , 10 V_{RMS}
- Input Noise Voltage: 5.0 nV/ \sqrt{Hz} (Typical)
- DC Voltage Gain: 50000
- AC Voltage Gain: 2200 at 10 kHz
- Power Bandwidth: 140 kHz
- Slew Rate: 9.0 V/ μ s
- Large Supply Voltage Range: ± 3.0 to ± 20 V
- Compensated for Unity Gain
- Pb-Free Packages are Available

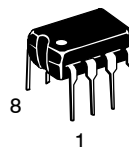


ON Semiconductor®

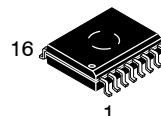
<http://onsemi.com>



SOIC-8
D SUFFIX
CASE 751



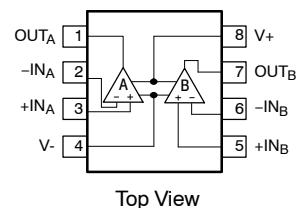
PDIP-8
N SUFFIX
CASE 626



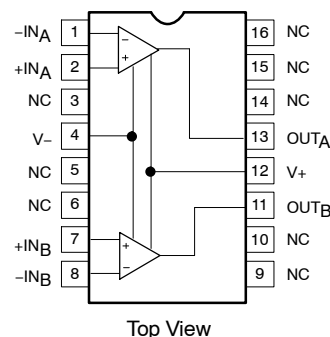
SOIC-16 WB
D SUFFIX
CASE 751G

PIN CONNECTIONS

N, D8 Packages



D Package*



*SOL and non-standard pinout.

DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 6 of this data sheet.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

NE5532, SA5532, SE5532, NE5532A, SE5532A

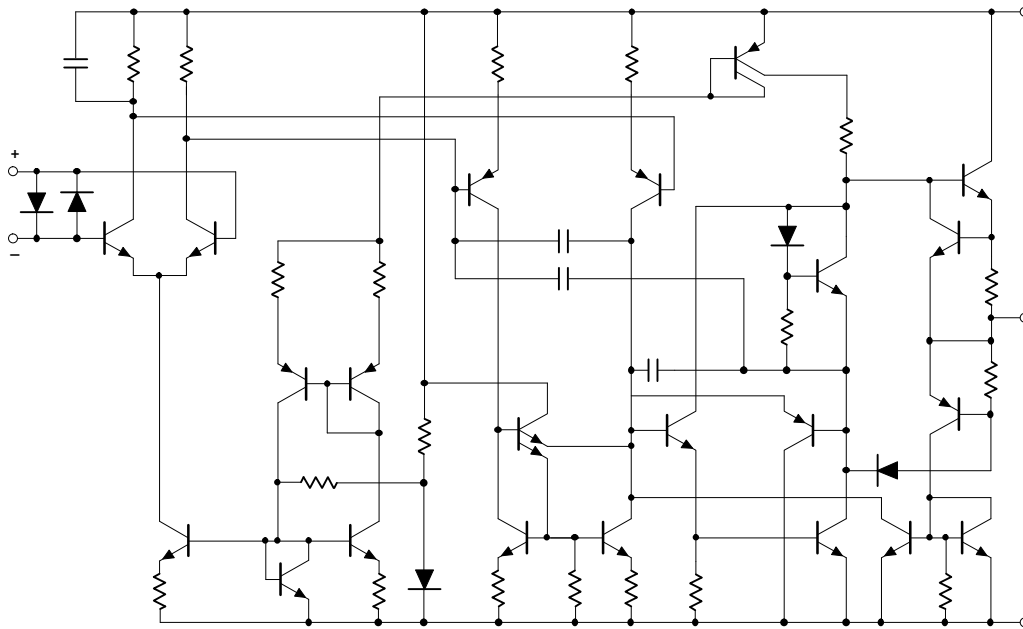


Figure 1. Equivalent Schematic (Each Amplifier)

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Supply Voltage	V_S	± 22	V
Input Voltage	V_{IN}	$\pm V_{SUPPLY}$	V
Differential Input Voltage (Note 1)	V_{DIFF}	± 0.5	V
Operating Temperature Range NE5532/A SA5532 SE5532/A	T_{amb}	0 to 70 -40 to +85 -55 to +125	$^{\circ}C$
Storage Temperature	T_{stg}	-65 to +150	$^{\circ}C$
Junction Temperature	T_j	150	$^{\circ}C$
Maximum Power Dissipation, $T_{amb} = 25^{\circ}C$ (Still-Air) 8 D8 Package 8 N Package 16 D Package	P_D	780 1200 1200	mW
Thermal Resistance, Junction-to-Ambient 8 D8 Package 8 N Package 16 D Package	$R_{\theta JA}$	182 130 140	$^{\circ}C/W$
Lead Soldering Temperature (10 sec max)	T_{sld}	230	$^{\circ}C$

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- Diodes protect the inputs against overvoltage. Therefore, unless current-limiting resistors are used, large currents will flow if the differential input voltage exceeds 0.6 V. Maximum current should be limited to ± 10 mA.

NE5532, SA5532, SE5532, NE5532A, SE5532A

DC ELECTRICAL CHARACTERISTICS ($T_{amb} = 25^{\circ}\text{C}$; $V_S = \pm 15\text{ V}$, unless otherwise noted.) (Notes 2, 3 and 4)

Characteristic	Symbol	Test Conditions	SE5532/A			NE5532/A, SA5532			Unit
			Min	Typ	Max	Min	Typ	Max	
Offset Voltage	V_{OS}	-	-	0.5	2.0	-	0.5	4.0	mV
	-	Overtemperature	-	-	3.0	-	-	5.0	mV
	$\Delta V_{OS}/\Delta T$	-	-	5.0	-	-	5.0	-	$\mu\text{V}/^{\circ}\text{C}$
Offset Current	I_{OS}	-	-	-	100	-	10	150	nA
	-	Overtemperature	-	-	200	-	-	200	nA
	$\Delta I_{OS}/\Delta T$	-	-	200	-	-	200	-	$\text{pA}/^{\circ}\text{C}$
Input Current	I_B	-	-	300	500	-	300	800	nA
	-	Overtemperature	-	-	700	-	-	1000	nA
	$\Delta I_B/\Delta T$	-	-	5.0	-	-	5.0	-	$\text{nA}/^{\circ}\text{C}$
Supply Current	I_{CC}	-	-	8.0	10.5	-	8.0	16	mA
	-	Overtemperature	-	-	13	-	-	-	
Common-Mode Input Range	V_{CM}	-	± 12	± 13	-	± 12	± 13	-	V
Common-Mode Rejection Ratio	CMRR	-	80	100	-	70	100	-	dB
Power Supply Rejection Ratio	PSRR	-	-	10	50	-	10	100	$\mu\text{V}/\text{V}$
Large-Signal Voltage Gain	A_{VOL}	$R_L \geq 2.0\text{ k}\Omega$; $V_O = \pm 10\text{ V}$	50	100	-	25	100	-	V/mV
		Overtemperature	25	-	-	15	-	-	
		$R_L \geq 600\ \Omega$; $V_O = \pm 10\text{ V}$	40	50	-	15	50	-	
		Overtemperature	20	-	-	10	-	-	
Output Swing	V_{OUT}	$R_L \geq 600\ \Omega$	± 12	± 13	-	± 12	± 13	-	V
		Overtemperature	± 10	± 12	-	± 10	± 12	-	
		$R_L \geq 600\ \Omega$; $V_S = \pm 18\text{ V}$	± 15	± 16	-	± 15	± 16	-	
		Overtemperature	± 12	± 14	-	± 12	± 14	-	
		$R_L \geq 2.0\text{ k}\Omega$	± 13	± 13.5	-	± 13	± 13.5	-	
Overtemperature	± 12	± 12.5	-	± 10	± 12.5	-			
Input Resistance	R_{IN}	-	30	300	-	30	300	-	$\text{k}\Omega$
Output Short Circuit Current	I_{SC}	-	10	38	60	10	38	60	mA

2. Diodes protect the inputs against overvoltage. Therefore, unless current-limiting resistors are used, large currents will flow if the differential input voltage exceeds 0.6 V. Maximum current should be limited to $\pm 10\text{ mA}$.
3. For operation at elevated temperature, derate packages based on the package thermal resistance.
4. Output may be shorted to ground at $V_S = \pm 15\text{ V}$, $T_{amb} = 25^{\circ}\text{C}$. Temperature and/or supply voltages must be limited to ensure dissipation rating is not exceeded.

NE5532, SA5532, SE5532, NE5532A, SE5532A

AC ELECTRICAL CHARACTERISTICS ($T_{amb} = 25^{\circ}\text{C}$; $V_S = \pm 15\text{ V}$, unless otherwise noted.)

Characteristic	Symbol	Test Conditions	NE/SE5532/A, SA5532			Unit
			Min	Typ	Max	
Output Resistance	R_{OUT}	$A_V = 30\text{ dB}$ Closed-loop $f = 10\text{ kHz}$, $R_L = 600\ \Omega$	–	0.3	–	Ω
Overshoot	–	Voltage-Follower $V_{IN} = 100\text{ mV}_{P-P}$ $C_L = 100\text{ pF}$; $R_L = 600\ \Omega$	–	10	–	%
Gain	A_V	$f = 10\text{ kHz}$	–	2.2	–	V/mV
Gain Bandwidth Product	GBW	$C_L = 100\text{ pF}$; $R_L = 600\ \Omega$	–	10	–	MHz
Slew Rate	SR	–	–	9.0	–	V/ μs
Power Bandwidth	–	$V_{OUT} = \pm 10\text{ V}$ $V_{OUT} = \pm 14\text{ V}$; $R_L = 600\ \Omega$ $V_{CC} = \pm 18\text{ V}$	–	140 100	–	kHz

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25^{\circ}\text{C}$; $V_S = \pm 15\text{ V}$, unless otherwise noted.)

Characteristic	Symbol	Test Conditions	NE/SE5532			NE/SA/SE5532A			Unit
			Min	Typ	Max	Min	Typ	Max	
Input Noise Voltage	V_{NOISE}	$f_O = 30\text{ Hz}$	–	8.0	–	–	8.0	12	nV/ $\sqrt{\text{Hz}}$
		$f_O = 1.0\text{ kHz}$	–	5.0	–	–	5.0	6.0	
Input Noise Current	I_{NOISE}	$f_O = 30\text{ Hz}$	–	2.7	–	–	2.7	–	pA/ $\sqrt{\text{Hz}}$
		$f_O = 1.0\text{ kHz}$	–	0.7	–	–	0.7	–	
Channel Separation	–	$f = 1.0\text{ kHz}$; $R_S = 5.0\text{ k}\Omega$	–	110	–	–	110	–	dB

TYPICAL PERFORMANCE CHARACTERISTICS

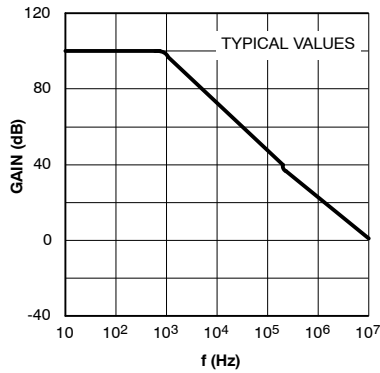


Figure 2. Open-Loop Frequency Response

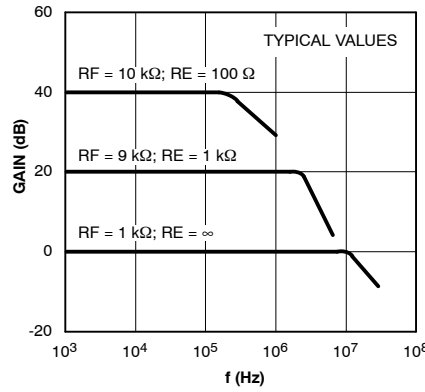


Figure 3. Closed-Loop Frequency Response

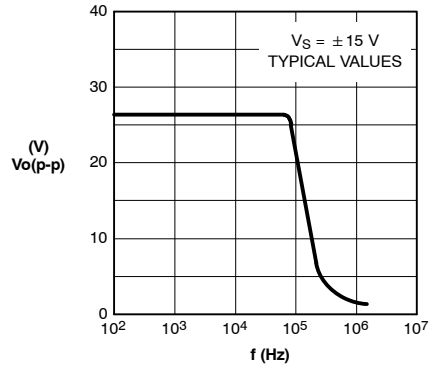


Figure 4. Large-Signal Frequency Response

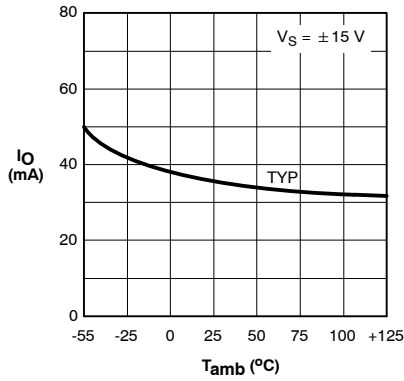


Figure 5. Output Short-Circuit Current

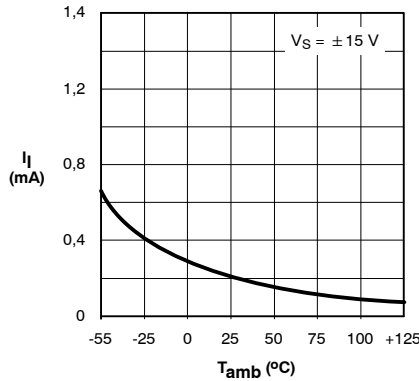


Figure 6. Input Bias Current

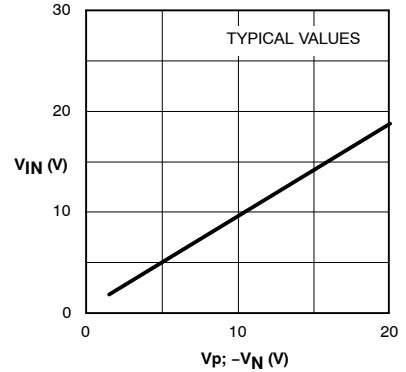


Figure 7. Input Common-Mode Voltage Range

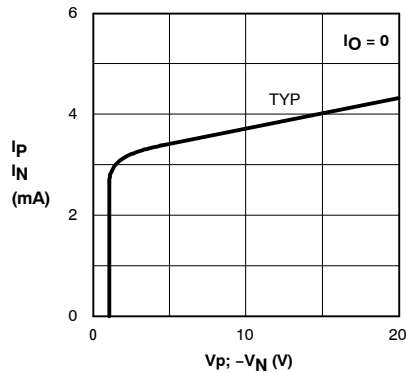


Figure 8. Supply Current

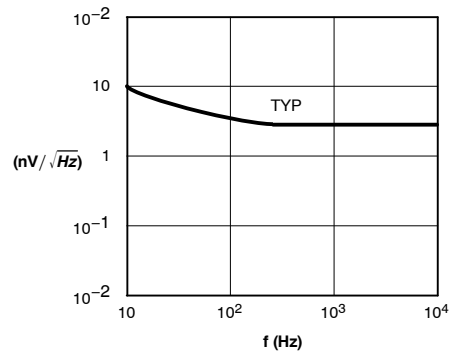


Figure 9. Input Noise Voltage Density

NE5532, SA5532, SE5532, NE5532A, SE5532A

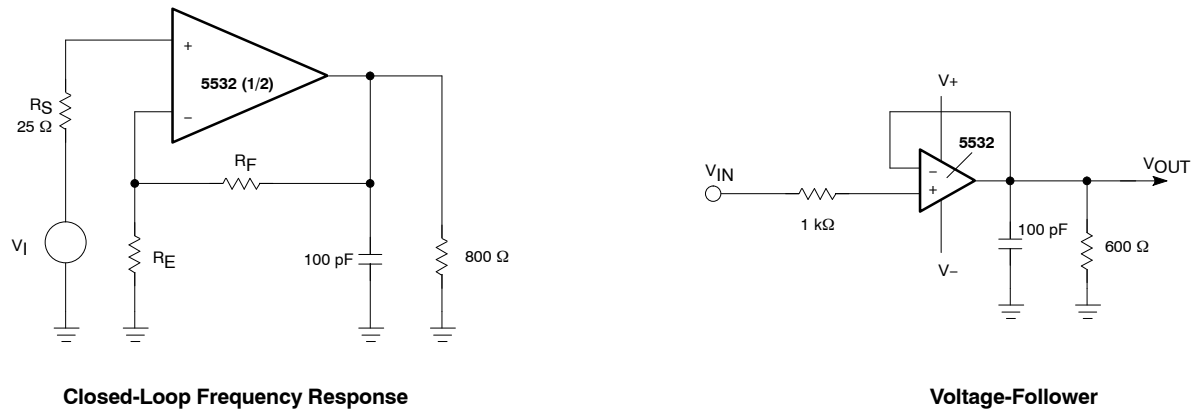
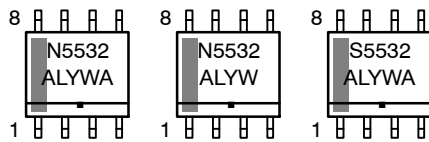
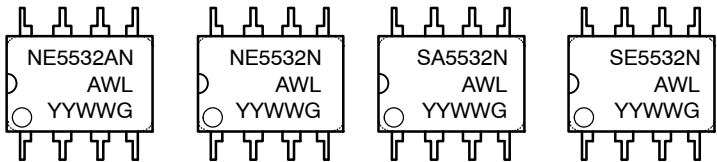


Figure 10. Test Circuits

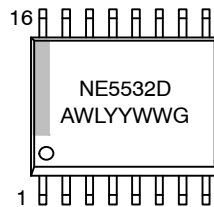
MARKING DIAGRAMS



**SOIC-8
D SUFFIX
CASE 751**



**PDIP-8
N SUFFIX
CASE 626**



**SOIC-16 WB
D SUFFIX
CASE 751G**

- A = Assembly Location
- WL, L = Wafer Lot
- YY, Y = Year
- WW, W = Work Week
- G or ■ = Pb-Free Package

NE5532, SA5532, SE5532, NE5532A, SE5532A

ORDERING INFORMATION

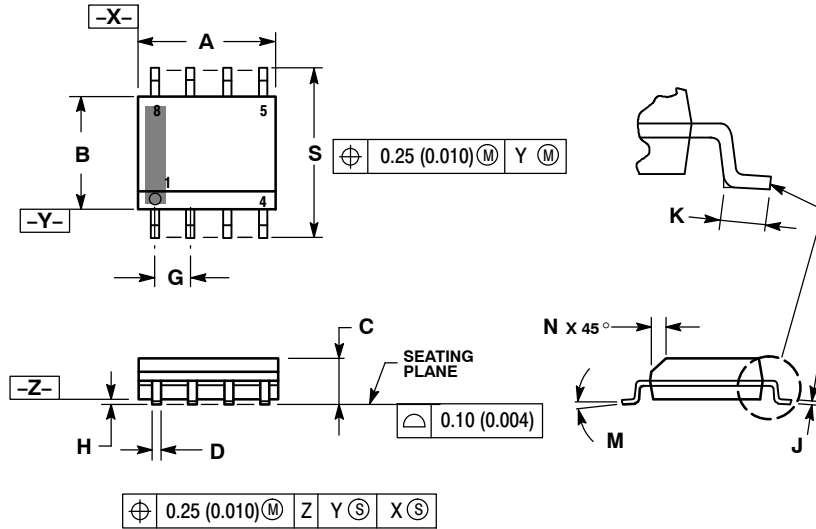
Device	Description	Temperature Range	Shipping†	
NE5532AD8	8-Pin Plastic Small Outline (SO-8) Package	0 to 70°C	98 Units / Rail	
NE5532AD8G	8-Pin Plastic Small Outline (SO-8) Package (Pb-Free)		98 Units / Rail	
NE5532AD8R2	8-Pin Plastic Small Outline (SO-8) Package		2500 / Tape & Reel	
NE5532AD8R2G	8-Pin Plastic Small Outline (SO-8) Package (Pb-Free)		2500 / Tape & Reel	
NE5532AN	8-Pin Plastic Dual In-Line Package (PDIP-8)		50 Units / Rail	
NE5532ANG	8-Pin Plastic Dual In-Line Package (PDIP-8) (Pb-Free)		50 Units / Rail	
NE5532D	16-Pin Plastic Small Outline (SO-16 WB) Package		47 Units / Rail	
NE5532DG	16-Pin Plastic Small Outline (SO-16 WB) Package (Pb-Free)		47 Units / Rail	
NE5532DR2	16-Pin Plastic Small Outline (SO-16 WB) Package		1000 Tape & Reel	
NE5532DR2G	16-Pin Plastic Small Outline (SO-16 WB) Package (Pb-Free)		1000 Tape & Reel	
NE5532D8	8-Pin Plastic Small Outline (SO-8) Package		98 Units / Rail	
NE5532D8G	8-Pin Plastic Small Outline (SO-8) Package (Pb-Free)		98 Units / Rail	
NE5532D8R2	8-Pin Plastic Small Outline (SO-8) Package		2500 / Tape & Reel	
NE5532D8R2G	8-Pin Plastic Small Outline (SO-8) Package (Pb-Free)		2500 / Tape & Reel	
NE5532N	8-Pin Plastic Dual In-Line Package (PDIP-8)		50 Units / Rail	
NE5532NG	8-Pin Plastic Dual In-Line Package (PDIP-8) (Pb-Free)		50 Units / Rail	
SA5532N	8-Pin Plastic Dual In-Line Package (PDIP-8)		-40 to +85°C	50 Units / Rail
SA5532NG	8-Pin Plastic Dual In-Line Package (PDIP-8) (Pb-Free)			50 Units / Rail
SE5532AD8	8-Pin Plastic Small Outline (SO-8) Package	-55 to +125°C	98 Units / Rail	
SE5532AD8G	8-Pin Plastic Small Outline (SO-8) Package (Pb-Free)		98 Units / Rail	
SE5532AD8R2	8-Pin Plastic Small Outline (SO-8) Package		2500 / Tape & Reel	
SE5532AD8R2G	8-Pin Plastic Small Outline (SO-8) Package (Pb-Free)		2500 / Tape & Reel	
SE5532N	8-Pin Plastic Dual In-Line Package (PDIP-8)		50 Units / Rail	
SE5532NG	8-Pin Plastic Dual In-Line Package (PDIP-8) (Pb-Free)		50 Units / Rail	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NE5532, SA5532, SE5532, NE5532A, SE5532A

PACKAGE DIMENSIONS

SOIC-8 NB
CASE 751-07
ISSUE AK

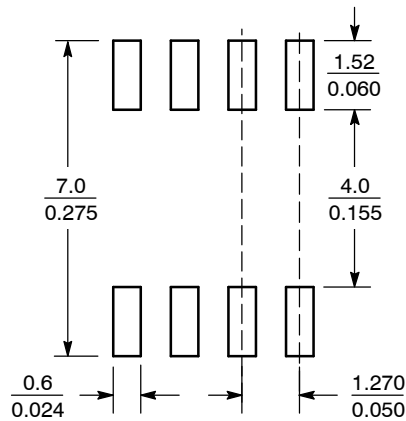


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.80	5.00	0.189	0.197
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27 BSC		0.050 BSC	
H	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
K	0.40	1.27	0.016	0.050
M	0°	8°	0°	8°
N	0.25	0.50	0.010	0.020
S	5.80	6.20	0.228	0.244

SOLDERING FOOTPRINT*



SCALE 6:1 (mm/inches)

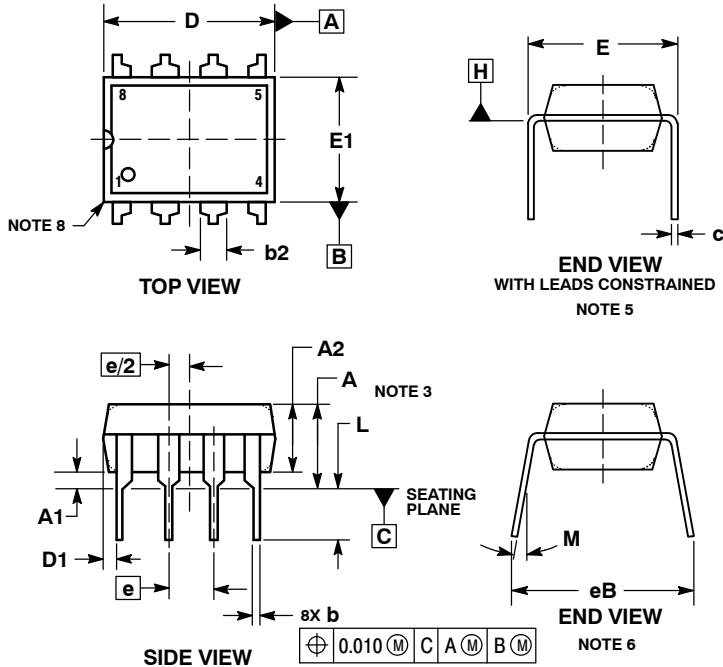
*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

NE5532, SA5532, SE5532, NE5532A, SE5532A

PACKAGE DIMENSIONS

8-Pin Plastic Dual In-Line Package (PDIP-8)

N SUFFIX
CASE 626-05
ISSUE N



NOTES:

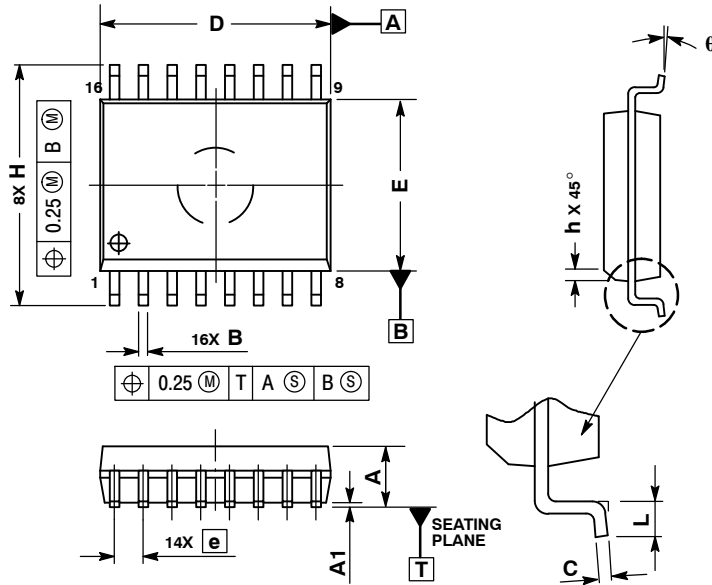
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: INCHES.
3. DIMENSIONS A, A1 AND L ARE MEASURED WITH THE PACKAGE SEATED IN JEDEC SEATING PLANE GAUGE GS-3.
4. DIMENSIONS D, D1 AND E1 DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS ARE NOT TO EXCEED 0.10 INCH.
5. DIMENSION E IS MEASURED AT A POINT 0.015 BELOW DATUM PLANE H WITH THE LEADS CONSTRAINED PERPENDICULAR TO DATUM C.
6. DIMENSION E3 IS MEASURED AT THE LEAD TIPS WITH THE LEADS UNCONSTRAINED.
7. DATUM PLANE H IS COINCIDENT WITH THE BOTTOM OF THE LEADS, WHERE THE LEADS EXIT THE BODY.
8. PACKAGE CONTOUR IS OPTIONAL (ROUNDED OR SQUARE CORNERS).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	----	0.210	----	5.33
A1	0.015	----	0.38	----
A2	0.115	0.195	2.92	4.95
b	0.014	0.022	0.35	0.56
b2	0.060 TYP		1.52 TYP	
C	0.008	0.014	0.20	0.36
D	0.355	0.400	9.02	10.16
D1	0.005	----	0.13	----
E	0.300	0.325	7.62	8.26
E1	0.240	0.280	6.10	7.11
e	0.100 BSC		2.54 BSC	
eB	----	0.430	----	10.92
L	0.115	0.150	2.92	3.81
M	----	10°	----	10°

NE5532, SA5532, SE5532, NE5532A, SE5532A

PACKAGE DIMENSIONS

SOIC-16 WB
D SUFFIX
CASE 751G-03
ISSUE D

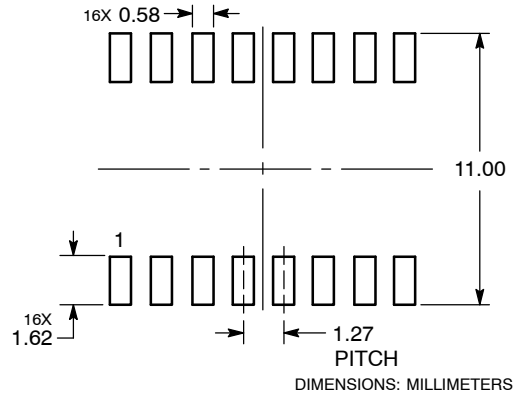


NOTES:

1. DIMENSIONS ARE IN MILLIMETERS.
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF THE B DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS	
	MIN	MAX
A	2.35	2.65
A1	0.10	0.25
B	0.35	0.49
C	0.23	0.32
D	10.15	10.45
E	7.40	7.60
e	1.27 BSC	
H	10.05	10.55
h	0.25	0.75
L	0.50	0.90
q	0°	7°

SOLDERING FOOTPRINT



ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of SCILLC's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Literature Distribution Center for ON Semiconductor
P.O. Box 5163, Denver, Colorado 80217 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free
USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com
Order Literature: <http://www.onsemi.com/orderlit>

For additional information, please contact your local Sales Representative

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [Operational Amplifiers - Op Amps](#) category:

Click to view products by [ON Semiconductor](#) manufacturer:

Other Similar products are found below :

[OPA2991IDSGR](#) [OPA607IDCKT](#) [007614D](#) [633773R](#) [635798C](#) [635801A](#) [702115D](#) [709228FB](#) [741528D](#) [NCV33072ADR2G](#) [SC2903DR2G](#)
[SC2903VDR2G](#) [LM258AYDT](#) [LM358SNG](#) [430227FB](#) [430228DB](#) [460932C](#) [AZV831KTR-G1](#) [409256CB](#) [430232AB](#) [LM2904DR2GH](#)
[LM358YDT](#) [LT1678IS8](#) [042225DB](#) [058184EB](#) [070530X](#) [714228XB](#) [714846BB](#) [873836HB](#) [MIC918YC5-TR](#) [TS912BIYDT](#)
[NCS2004MUTAG](#) [NCV33202DMR2G](#) [M38510/13101BPA](#) [NTE925](#) [SC2904DR2G](#) [SC358DR2G](#) [LM358EDR2G](#) [AZV358MTR-G1](#)
[AP4310AUMTR-AG1](#) [HA1630D02MMEL-E](#) [NJM358CG-TE2](#) [HA1630S01LPEL-E](#) [LM324AWPT](#) [HA1630Q06TELL-E](#) [NJM4558CG-TE2](#)
[AZV358MMTR-G1](#) [SCY33178DR2G](#) [NCS4325DR2G](#) [LM7301SN1T1G](#)